/ Revised record

A	2019.12.24				
A	2021-12-24	6-7	TO-252#		
A	2022-6-17		BRCS50N06DP 251		

/ Descriptions

! " # $ % & '

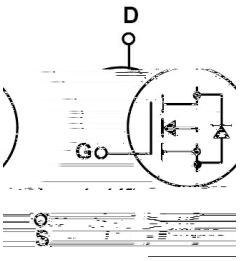
/ Features

DS(on) ( ) * + , -) rss ( ) . / 0 1 2) ! 3 4 5) 6 7 8 9 '

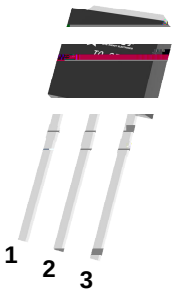
/ Applications

: ; - < + = > ? @ A + = B C D B E F G 8 9 H + I J $ C D '

/ Equivalent Circuit



/ Pinning



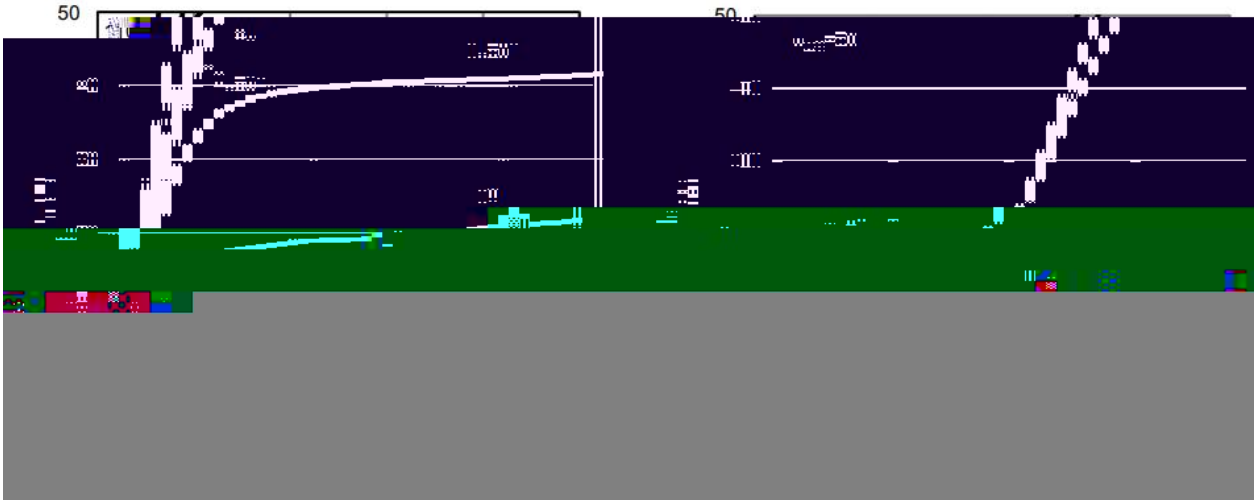
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/ Marking

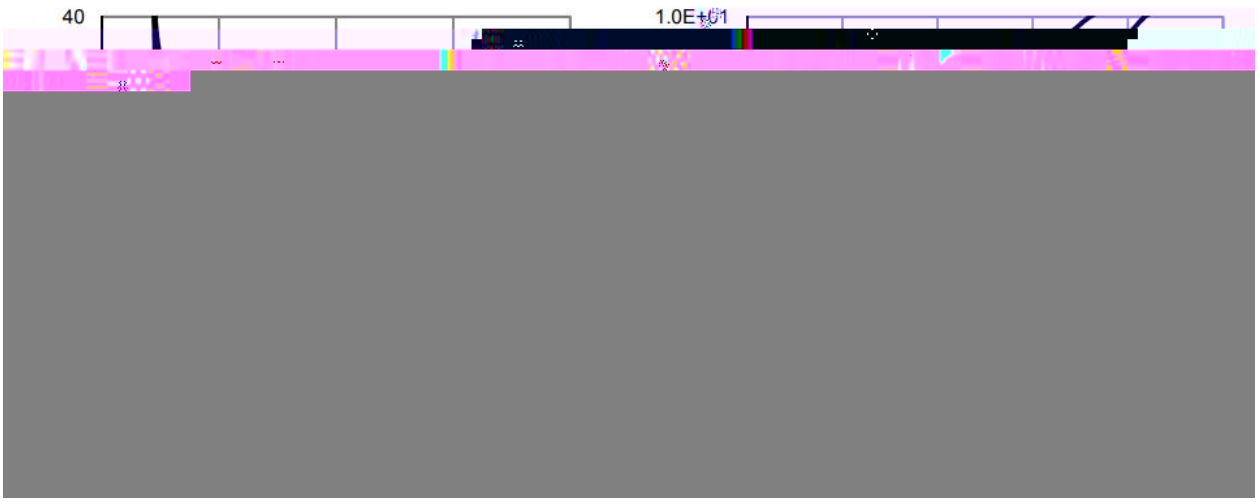
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BRCS50N06IP

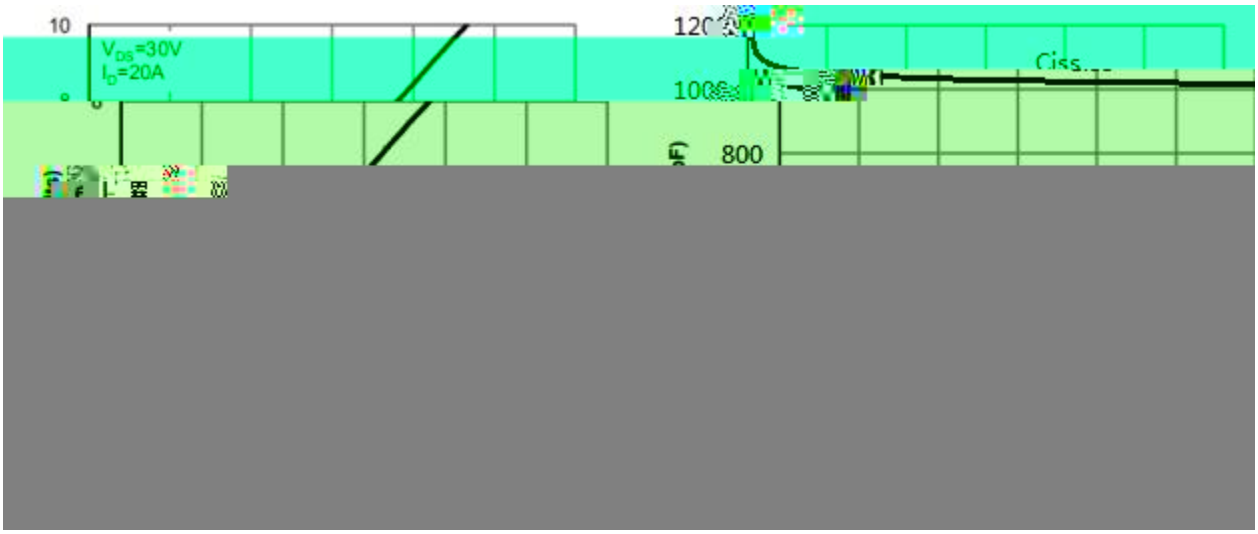
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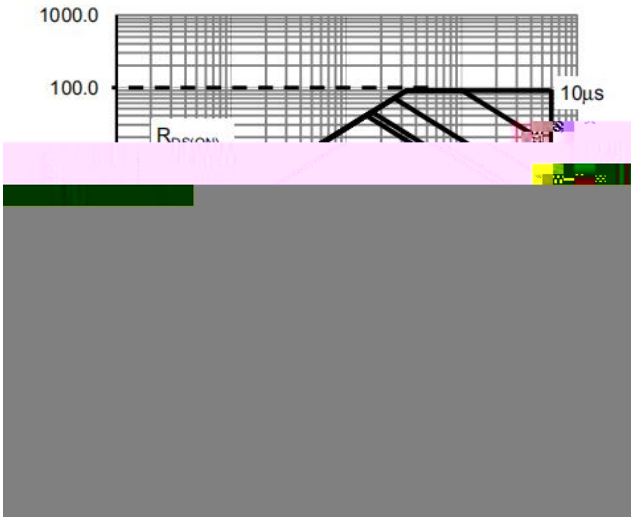




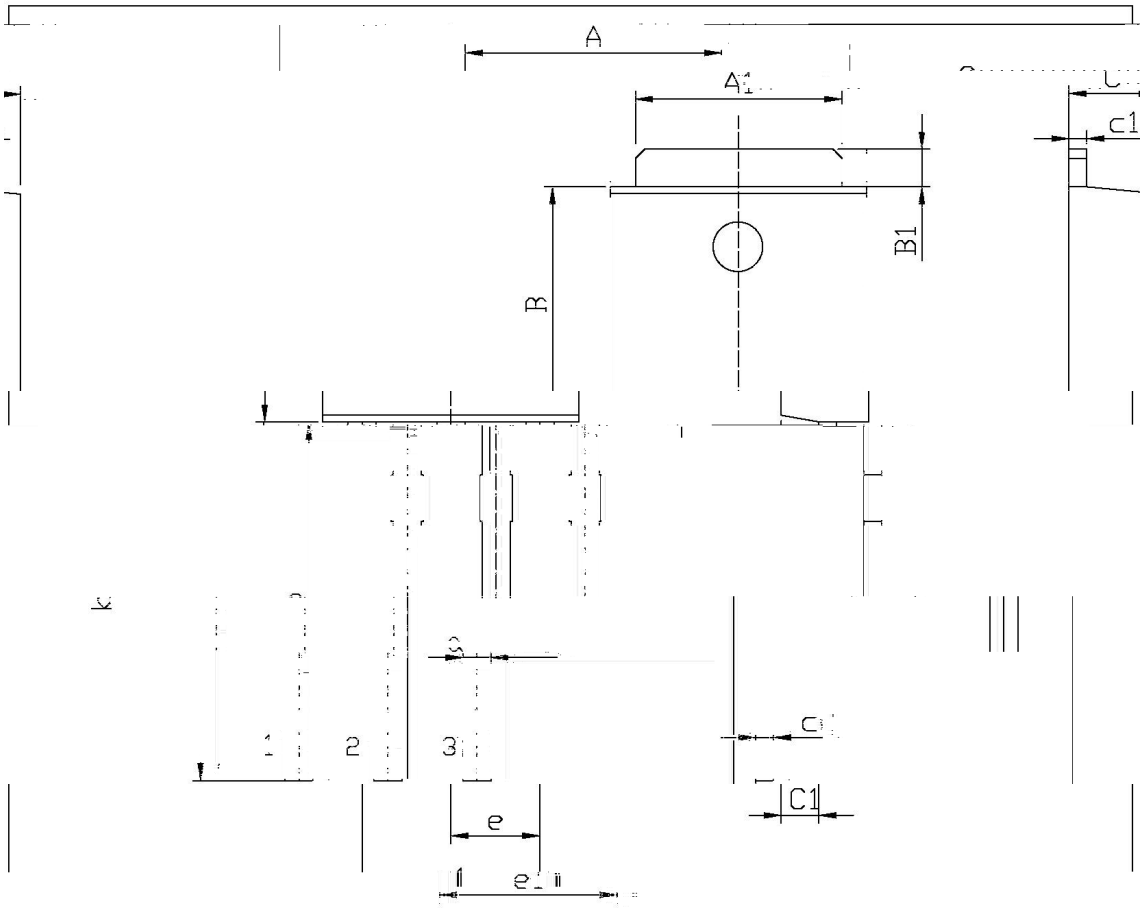


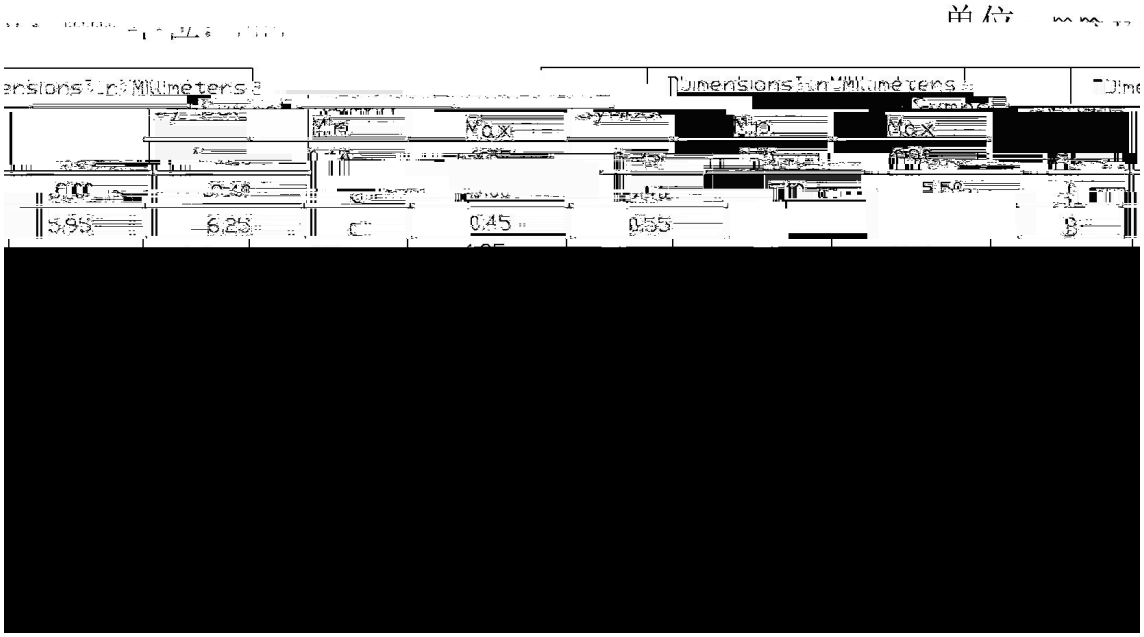
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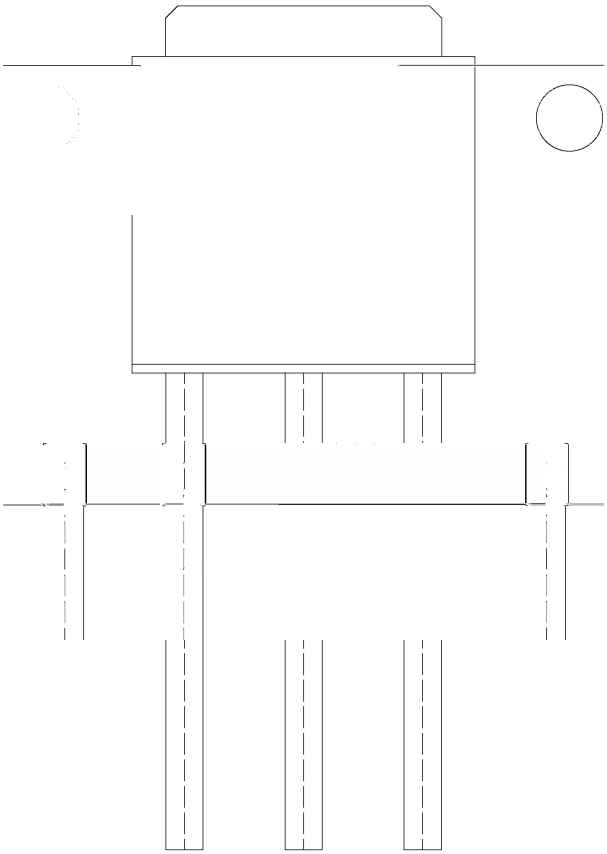


/ Package Dimensions





/ Marking Instructions



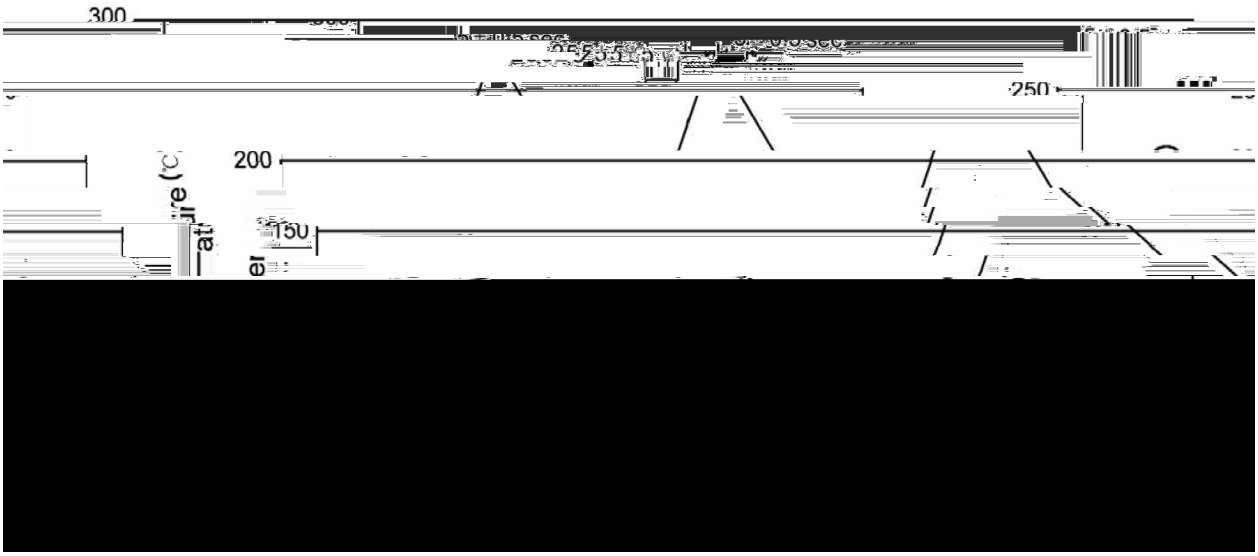
说明：

：　　为公司代码

：　　为型号代码

****：　　为生产批号代码，随生产批号变化

( ) / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	包装数量	包装尺寸 :
封装形式	只/袋 袋/盒	